Specifications

Insulation Resistance: 1000M Ω at 100 V DC for 1 minute

Current Rating: 1A max. per contact Voltage Rating: 30V ACrms max.

Withstanding Voltage: 500V AC (rms) for 1 minute

Contact Resistance: 30m Ω max. (initial)



USB-M04-003



Materials and Finish

Housing: Thermoplastic, glass filled (UL94V-0)

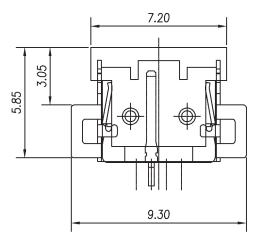
Shell: Tin over Copper Alloy

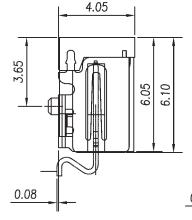
Contacts: Copper Alloy

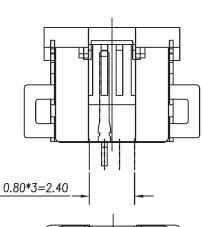
Contact Plating: Solder area - Solder over Nickel

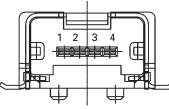
Mating area - Au over Nickel

Outline Dimensions SMT Type

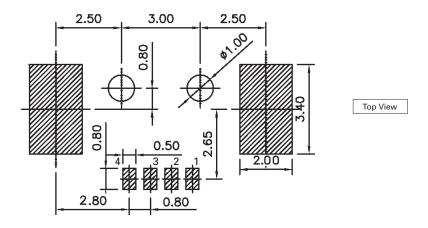








Recommended PCB Layout



Series USB-M Mini USB - Plug (4 Pin Solder Port)



Insulation Resistance: Withstanding Voltage: Voltage Rating: **Current Rating:** Contact Resistance:

Materials and Finish

1000M Ω at 100V DC for 1 minute 500V ACrms for 1 minute 30V AC (rms) max. 1A max. per contact 15m Ω max. (initial)

Thermoplastic, glass filled (UL94V-0)

Tin over Copper Alloy

Mating area - Au over Nickel

Copper Alloy Contact Plating: Solder area - Sn over Nickel



Part Number

USB-M04-P

Assembly set with plastic cover

Note:

USB-M04-P is also available in assembled version with moulded strain relief. For more details please contact Yamaichi.





Housing: Shell:

Contacts:

Outline Dimensions Plug

